

Set Name Query

side by side

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result set

DB=USPT,PGPB,JPAB,EPAB,DWPI,TDBD; PLUR=YES; OP=ADJ

| | | | |
|-----------|---|-----|-----------|
| <u>L3</u> | polyamide and organic halogen compound [ti] | 13 | <u>L3</u> |
| <u>L2</u> | polyamide and organic halogen compound | 320 | <u>L2</u> |
| <u>L1</u> | polyamide and organic halogen compound and copper complex | 1 | <u>L1</u> |

END OF SEARCH HISTORY

WEST

Generate Collection

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Search Results - Record(s) 1 through 13 of 13 returned.☐ 1. Document ID: US 4239609 A

L3: Entry 1 of 13

File: USPT

Dec 16, 1980

US-PAT-NO: 4239609

DOCUMENT-IDENTIFIER: US 4239609 A

TITLE: Photopolymerizable coating and recording materials containing a photoinitiator and an organic halogen compound

DATE-ISSUED: December 16, 1980

INVENTOR-INFORMATION:

| NAME | CITY | STATE | ZIP CODE | COUNTRY |
|-------------------|---------------|-------|----------|---------|
| Barzynski; Helmut | Bad Duerkheim | | | DE |
| Saenger; Dietrich | Frankenthal | | | DE |

US-CL-CURRENT: 522/23; 430/286.1, 522/10, 522/117, 522/121, 522/96

| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments | Claims | KWIC |
|-----------|-------|----------|-------|--------|----------------|------|-----------|-----------|-------------|--------|------|
| Draw Desc | Image | | | | | | | | | | |

☐ 2. Document ID: US 3754914 A

L3: Entry 2 of 13

File: USPT

Aug 28, 1973

US-PAT-NO: 3754914

DOCUMENT-IDENTIFIER: US 3754914 A

** See image for Certificate of Correction **

TITLE: PHOTSENSITIVE COMPOSITION CONTAINING AN ORGANIC HALOGEN COMPOUND
PHOTOACTIVATOR, A COLOR MODIFIER AND A PHOTOREDUCTIBLE ORGANIC METAL SALT AND THE USE THEREOF

DATE-ISSUED: August 28, 1973

INVENTOR-INFORMATION:

| NAME | CITY | STATE | ZIP CODE | COUNTRY |
|----------------|-------|-------|----------|---------|
| Inoue; Eiichi | Tokyo | | | JA |
| Shimizu; Isamu | Tokyo | | | JA |

US-CL-CURRENT: 430/335; 430/338, 430/339, 430/341, 430/344, 430/345, 430/962

| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments | Claims | KWIC |
|-----------|-------|----------|-------|--------|----------------|------|-----------|-----------|-------------|--------|------|
| Draw Desc | Image | | | | | | | | | | |

☐ 3. Document ID: WO 22035 A1

L3: Entry 3 of 13

File: EPAB

Apr 20, 2000

PUB-NO: WO000022035A1

DOCUMENT-IDENTIFIER: WO 22035 A1

TITLE: POLYAMIDE COMPOSITION STABILIZED WITH COPPER COMPLEXES AND ORGANIC HALOGEN COMPOUNDS

PUBN-DATE: April 20, 2000

INVENTOR-INFORMATION:

NAME

TITZSCHKAU, KLAUS

COUNTRY

DE

INT-CL (IPC): C08 K 5/00; C08 L 77/00; C08 K 5/02

EUR-CL (EPC): C08K005/00; C08K005/02

| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments |
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| Draw Desc | Image | | | | | | | | |

KIMC

☐ 4. Document ID: JP 2000186205 A

L3: Entry 4 of 13

File: DWPI

Jul 4, 2000

DERWENT-ACC-NO: 2000-589642

DERWENT-WEEK: 200056

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TITLE: Polyamide resin composition, useful for producing automobile parts, etc., includes polyamide dicarboxylic acid unit and diamine unit, organic halogen compound and antioxidant.

PRIORITY-DATA: 1998JP-0364653 (December 22, 1998)

PATENT-FAMILY:

PUB-NO

JP 2000186205 A

PUB-DATE

July 4, 2000

LANGUAGE

PAGES

007

MAIN-IPC

C08L077/06

INT-CL (IPC): C08 K 5/134; C08 K 5/36; C08 L 77/06; C08 L 77/06; C08 L 25:04

| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments |
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| Draw Desc | Image | | | | | | | | |

KIMC

☐ 5. Document ID: JP 2000186206 A

L3: Entry 5 of 13

File: DWPI

Jul 4, 2000

DERWENT-ACC-NO: 2000-581620

DERWENT-WEEK: 200060

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TITLE: Polyamide resin composition, useful for producing automobile parts, includes polyamide dicarboxylic acid unit and diamine unit, and organic halogen compound

PRIORITY-DATA: 1998JP-0364658 (December 22, 1998)

PATENT-FAMILY:

| | | | | |
|-----------------|--------------|----------|-------|------------|
| PUB-NO | PUB-DATE | LANGUAGE | PAGES | MAIN-IPC |
| JP 2000186206 A | July 4, 2000 | | 007 | C08L077/06 |

INT-CL (IPC): C08 K 5/02; C08 L 77/06

| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments |
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| Draw Desc | Image | | | | | | | | |

KWC

☐ 6. Document ID: JP 06184431 A

L3: Entry 6 of 13

File: DWPI

Jul 5, 1994

DERWENT-ACC-NO: 1994-253002

DERWENT-WEEK: 199431

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TITLE: Flame retardant polyamide resin compsn. for resistance to thermal ageing - comprises polyamide, organic halogen cpd., flame retarding auxiliary, phosphite cpd. and filler, for reduced generation of gas and sticking of prod. to mould

PRIORITY-DATA: 1992JP-0355445 (December 21, 1992)

PATENT-FAMILY:

| | | | | |
|---------------|--------------|----------|-------|------------|
| PUB-NO | PUB-DATE | LANGUAGE | PAGES | MAIN-IPC |
| JP 06184431 A | July 5, 1994 | | 010 | C08L077/00 |

INT-CL (IPC): C08K 3/22; C08K 3/24; C08K 3/38; C08K 5/02; C08K 5/524; C08L 77/00; C09K 21/14

| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments |
|-----------|----------|----------|-------|--------|----------------|------|-----------|-----------|-------------|
| Draw Desc | Clip Img | Image | | | | | | | |

KWC

☐ 7. Document ID: JP 06065482 A JP 3268468 B2

L3: Entry 7 of 13

File: DWPI

Mar 8, 1994

DERWENT-ACC-NO: 1994-115347

DERWENT-WEEK: 200222

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TITLE: Extrusion formed sheet for electrical insulating board - obtd. by extrusion moulding mixt. contg. fibrous reinforcing material, inorganic cpd. organic halogen cpd. sodium antimonate and polyester resin.

PRIORITY-DATA: 1992JP-0245962 (August 24, 1992)

PATENT-FAMILY:

| | | | | |
|---------------|----------------|----------|-------|------------|
| PUB-NO | PUB-DATE | LANGUAGE | PAGES | MAIN-IPC |
| JP 06065482 A | March 8, 1994 | | 006 | C08L067/02 |
| JP 3268468 B2 | March 25, 2002 | | 006 | C08L067/02 |

INT-CL (IPC): C08J 5/18; C08K 3/00; C08K 3/24; C08K 3/34; C08K 5/02; C08K 7/02; C08L 67/02; H01B 3/42

| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments |
|-----------|-------|----------|-------|--------|----------------|------|-----------|-----------|-------------|
| Draw Desc | Image | | | | | | | | |

KWC

☐ 8. Document ID: US 4960517 A AU 641675 B CA 2022612 A

L3: Entry 8 of 13

File: DWPI

Oct 2, 1990

DERWENT-ACC-NO: 1990-319755

DERWENT-WEEK: 199042

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TITLE: Treatment of polyamide composite membranes for reverse osmosis - with amine reactive reagent e.g. organic halogen cpd., carboxylic anhydride, sultone, to red. passage of sulphuric acid

INVENTOR: CADOTTE, J E; PETERSEN, R J ; RACCHINI, J

PRIORITY-DATA: 1989US-0450705 (December 13, 1989), 1989US-0450706 (December 13, 1989), 1989US-0450691 (December 13, 1989)

PATENT-FAMILY:

| PUB-NO | PUB-DATE | LANGUAGE | PAGES | MAIN-IPC |
|--------------|--------------------|----------|-------|------------|
| US 4960517 A | October 2, 1990 | | 000 | |
| AU 641675 B | September 30, 1993 | | 000 | B01D071/56 |
| CA 2022612 A | June 14, 1991 | | 000 | |

INT-CL (IPC): B01D 61/02; B01D 69/12; B01D 71/56; C08J 9/36

| | | | | | | | | | |
|-----------|-------|----------|-------|--------|----------------|------|-----------|-----------|-------------|
| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments |
| Draw Desc | Image | | | | | | | | |

KWC

☐ 9. Document ID: JP 02029773 A

L3: Entry 9 of 13

File: DWPI

Jan 31, 1990

DERWENT-ACC-NO: 1990-078244

DERWENT-WEEK: 199011

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TITLE: Hologram mfr. - by using mixt. of high mol. polymer, organic halogen cpd. and die as hologram photosensitive material, applying UV ray and exposing

PRIORITY-DATA: 1988JP-0180576 (July 20, 1988)

PATENT-FAMILY:

| PUB-NO | PUB-DATE | LANGUAGE | PAGES | MAIN-IPC |
|---------------|------------------|----------|-------|----------|
| JP 02029773 A | January 31, 1990 | | 004 | |

INT-CL (IPC): G03H 1/04

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|-----------|-------|----------|-------|--------|----------------|------|-----------|-----------|-------------|
| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments |
| Draw Desc | Image | | | | | | | | |

KWC

☐ 10. Document ID: JP 62232450 A

L3: Entry 10 of 13

File: DWPI

Oct 12, 1987

DERWENT-ACC-NO: 1987-325285

DERWENT-WEEK: 198746

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TITLE: Flame-resistant thermoplastic resin compsn. - contg. polyamide elastomer, styrene! thermoplastic resin and organic halogen cpd.

PRIORITY-DATA: 1986JP-0075122 (April 1, 1986)

PATENT-FAMILY:

| PUB-NO | PUB-DATE | LANGUAGE | PAGES | MAIN-IPC |
|---------------|------------------|----------|-------|----------|
| JP 62232450 A | October 12, 1987 | | 007 | |

INT-CL (IPC): C08K 5/02; C08L 25/04

| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments | KMOC |
|------------|-------|----------|-------|--------|----------------|------|-----------|-----------|-------------|------|
| Drawn Desc | Image | | | | | | | | | |

☐ 11. Document ID: JP 56093758 A

L3: Entry 11 of 13

File: DWPI

Jul 29, 1981

DERWENT-ACC-NO: 1981-66952D

DERWENT-WEEK: 198137

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TITLE: Flame retarding resin compsn. - contg. rubber-contg. thermoplastic resin, organic halogen cpd. and sulphur and/or sulphur-contg. antioxidant

PRIORITY-DATA: 1979JP-0170513 (December 28, 1979)

PATENT-FAMILY:

| PUB-NO | PUB-DATE | LANGUAGE | PAGES | MAIN-IPC |
|---------------|---------------|----------|-------|----------|
| JP 56093758 A | July 29, 1981 | | 004 | |

INT-CL (IPC): C08K 5/02; C08K 21/00; C08L 101/00

| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments | KMOC |
|------------|-------|----------|-------|--------|----------------|------|-----------|-----------|-------------|------|
| Drawn Desc | Image | | | | | | | | | |

☐ 12. Document ID: JP 53043746 A

L3: Entry 12 of 13

File: DWPI

Apr 20, 1978

DERWENT-ACC-NO: 1978-39279A

DERWENT-WEEK: 197822

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TITLE: Flame-retardant polyamide resin compsns. - including polyamide resins, iron oxide, reinforcing agents, organic halogen cpd. and e.g. sodium stearate with methylene bis-stearyl-amide

PRIORITY-DATA: 1976JP-0118499 (October 4, 1976)

PATENT-FAMILY:

| PUB-NO | PUB-DATE | LANGUAGE | PAGES | MAIN-IPC |
|---------------|----------------|----------|-------|----------|
| JP 53043746 A | April 20, 1978 | | 000 | |

INT-CL (IPC): C08K 3/22; C08K 5/02; C08L 77/00

| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments | KMOC |
|------------|-------|----------|-------|--------|----------------|------|-----------|-----------|-------------|------|
| Drawn Desc | Image | | | | | | | | | |

☐ 13. Document ID: JP 73023963 B

L3: Entry 13 of 13

File: DWPI

DERWENT-ACC-NO: 1973-41411U

DERWENT-WEEK: 197329

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TITLE: Flameproof polyamide fibres prodn - using boric acid derivs and organic halogen cpds

PRIORITY-DATA: 1969JP-0079156 (October 6, 1969)

PATENT-FAMILY:

PUB-NO

PUB-DATE

LANGUAGE

PAGES

MAIN-IPC

JP 73023963 B

000

INT-CL (IPC): C08G 41/02; D01F 7/04

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|------------|-------|----------|-------|--------|----------------|------|-----------|-----------|-------------|
| Full | Title | Citation | Front | Review | Classification | Date | Reference | Sequences | Attachments |
| Draw. Desc | Image | | | | | | | | |

KMC

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| Term | Documents |
|---|-----------|
| POLYAMIDE | 187079 |
| POLYAMIDES | 71114 |
| ORGANIC | 1100058 |
| ORGANICS | 20020 |
| HALOGEN | 433480 |
| HALOGENS | 30591 |
| COMPOUND | 1347915 |
| CPD | 378534 |
| CPDS | 262855 |
| COMPOUNDS | 1354652 |
| (POLYAMIDE AND ORGANIC HALOGEN COMPOUND [TI]). USPT,PGPB,JPAB,EPAB,DWPI,TDBD. | 13 |

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